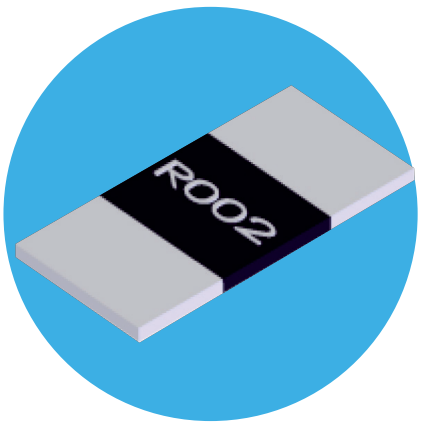
# Resistors

# Low Resistance Metal Alloy Resistor

**LRMA Series**

- Resistance range 0.5mΩ to 300mΩ
- High temperature operation to 170°C
- Low thermal EMF version
- High power version
- Current sensing for power electronics
- RoHS compliant & halogen free
- AEC-Q200 qualified




All parts are Pb-free and comply with EU Directive 2011/65/EU (RoHS2)

## Electrical Data

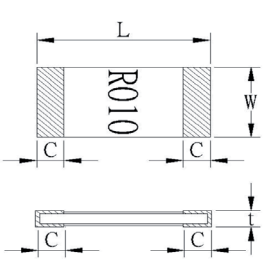
| LRMA Version | | T (Standard) | | P (Power) |
|---|---|---|---|---|
| Size | | 2010 | 2512 | 2512 |
| Power rating @70°C | W | 1.5 | ≤R01: 2, >R01: 1 | ≤R10: 3, >R10: 2 |
| Overload rating (5s) | W | 7.5 | ≤R01: 10, >R01: 5 | ≤R10: 15, >R10: 10 |
| Resistance range | mΩ | 5 to 100 | 1 to 100 | 0.5 to 300 |
| Standard values [1] | mΩ | 5, 6, 10, 15, 20, 50, 100 | 1, 1.5, 2, 3, 3.5, 4, 5, 6, 7, 8, 10, 11, 12, 15, 18, 20, 25, 30, 33, 35, 40, 50, 100 | 0.5, 0.75, 1, 1.1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 15, 18, 20, 22, 25, 27, 30, 33, 39, 40, 45, 47, 50, 57, 60, 68, 70, 75, 80, 85, 90, 100, 120, 130, 140, 150, 180, 200, 220, 240, 250, 270, 280, 300 |
| Resistance tolerance[1] | % | 1, 5 | | |
| TCR (25 to 125°C) | ppm/°C | ≥R01: ±75 | >R001 & <R01: ±100, ≤R001: ±275 | ±50 |
| Ambient temperature | °C | -55 to 170 | | |
| Insulation resistance | MΩ | >100 | | |
| Element alloy | | Cu-Ni | | Cu-Ni / Mn-Cu |
| Coating | | Black | | |

| LRMA Version | | M (Low thermal EMF) | | | N (Inverse) | |
|---|---|---|---|---|---|---|
| Size | | 0805 | 1206 | 2512 | 0612 | 0815 |
| Power rating @70°C | W | 0.5 | 1 | ≤R01: 2, >R01: 1 | 1 [2] | |
| Overload rating (5s) | W | 2.5 | 5 | ≤R01: 10, >R01: 5 | 5 | |
| Resistance range | mΩ | 5 to 25 | 1 to 50 | 0.5 to 60 | 1 to 3 | 3 to 30 |
| Standard values [1] | mΩ | 5, 6, 8,9, 10, 20, 25 | 1, 1.2, 2, 3, 4, 5, 6, 7, 8, 9, 10, 12, 14, 15, 18, 20, 22, 25, 30, 39, 40, 50 | 0.5, 0.75, 1, 1.5, 2, 3.5, 5, 10, 20, 25, 30, 40, 50, 60 | 1, 3 | 3, 4, 5, 10, 15, 20, 25, 30 |
| Resistance tolerance[1] | % | 1, 5 | | | | |
| TCR (25 to 125°C) | ppm/°C | ±100 | ±50 | ≥R01: ±75, >R001 & <R01: ±100 ≤R001: ±275 | ±100 | |
| Ambient temperature | | -55 to 170°C | | | | |
| Insulation resistance | MΩ | >100 | | | | |
| Element alloy | | Mn-Cu | | | Mn-Cu / Cu-Ni | |
| Coating | | Black | | Green | Black | |

Notes: 1. Non-standard values and tighter tolerances may be available for high volume requirements. 2. Requires 300mm$^2$ copper pad & trace area

## Physical Data (All dimensions in mm and nominal weight in mg)

| Size | L | W | C | t | Wt |
|---|---|---|---|---|---|
| **0805** | 2.0 ±0.1 | 1.25 ±0.1 | 0.4 ±0.2 | 0.6 ±0.2 | 5.5 |
| **1206** <R002 | 3.2 ±0.2 | 1.6 ±0.2 | 1.1 ±0.3 | 0.75 ±0.2 | 18.3 |
| **1206** ≥R002 | | | 0.5 ±0.3 | 0.6 ±0.2 | |
| **0612** | 1.7±0.2 | 3.2±0.2 | 0.4±0.2 | 0.6 ±0.2 | 12.9 |
| **0815** | 2.1 ±0.25 | 3.75 ±0.3 | 0.5 ±0.2 | 0.7 ±0.2 | 14.1 |
| **2010** | 5.0 ±0.2 | 2.5 ±0.2 | 0.6 ±0.3 | 0.6 ±0.2 | 35.6 |
| **2512** <R001 | 6.4 ±0.2 | 3.2 ±0.2 | 2.6 ±0.2 | 0.65 ±0.25 | 57 to 63 |
| **2512** ≥R001 & ≤R003 | | | 2.0 ±0.2 | | |
| **2512** >R003 | | | 0.9 ±0.2 | | |

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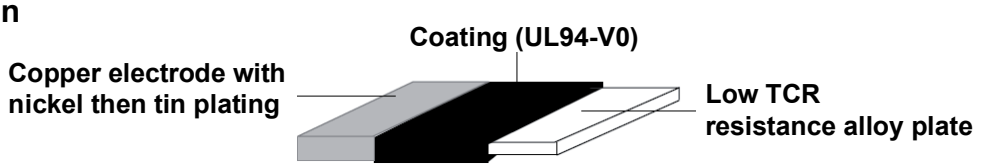
## Construction




## Marking

The components are marked with ohmic value, e.g. “R002” = 2mΩ, “R010” = 10 mΩ.
Due to space restrictions, for LRMAM1206-R001, "01" = 1mΩ is used, and for LRMAM0805, “002” = 2mΩ, “010” = 10 mΩ are used.

## Solvent Resistance

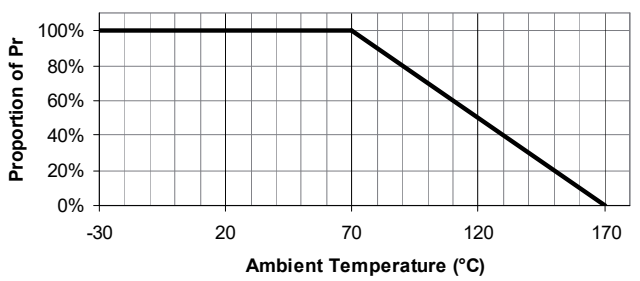
The component is resistant to all normal industrial cleaning solvents suitable for printed circuits.

# Performance Data

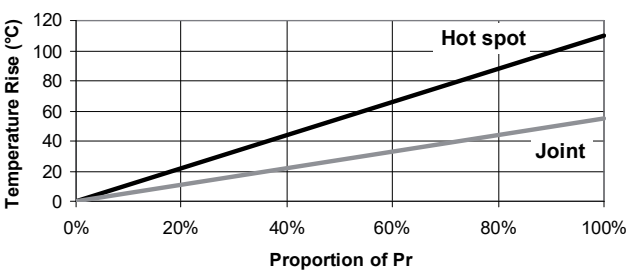
| | | Maximum (%) | Typical (%) |
|---|---|---|---|
| Load at rated power (cyclic load, 1000 hours at 70°C) | ±ΔR | 0805: 1.5 Others 1 | 0.3 |
| Short term overload (5 x rated power for 5s) | ±ΔR | 0.5 | 0.15 |
| Humidity (1000 hours, 85°C, 85%RH) | ±ΔR | 0805: 1 Others 0.5 | 0.15 |
| Temperature cycle (-40 to +125°C, 1000 cycles, 15 minute dwell) | ±ΔR | 0805: 1 Others 0.5 | 0.15 |
| Resistance to solder heat (260°C ±5°C for 20s ±1s) | ±ΔR | 0.5 | 0.3 |
| Solderability (245°C ±5°C for 2s ±0.5s) | | >95% coverage | |
| Dry heat (1000 hours at 170°C) | ±ΔR | 0805: 1.5 Others 0.5 | 0.3 |
| Low temperature storage (1000 hours at -55°C) | ±ΔR | 0.5 | 0.15 |
| Substrate bending (board 1.6mm, fulcrum spacing 90mm, deflection 2mm) | ±ΔR | 0805: 1 Others 0.5 | 0.3 |
| Insulation resistance (1 minute @ 100Vdc) | | >100M | |

## Thermal Performance & Mounting

**Temperature Derating**

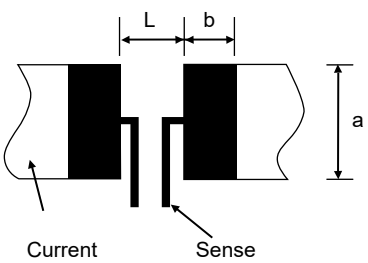



**Typical Temperature Rise**




**Reference Pad Dimensions (mm)**

| Size | a | b | L |
|---|---|---|---|
| 0612 | 3.8 | 0.7 | 0.7 |
| 0805 | 1.4 | 1.15 | 1.2 |
| 1206 <R002 | 1.8 | 2.3 | 1.0 |
| 1206 ≥R002 | 1.8 | 1.7 | 1.6 |
| 0815 | 7.9 | 1.5 | 0.9 |
| 2010 | 3.4 | 1.5 | 3.5 |
| 2512 ≤R003 | 4.0 | 3.1 | 1.3 |
| 2512 >R003 | 4.0 | 2.1 | 4.1 |




The temperature rise shown is highly dependent on mounting conditions. Reference conditions assume 20µ copper with thermal vias to multiple layers.
The self-heating in the current tracks should be kept negligible, or allowed for by temperature derating.

Standard 4-terminal probe pitches for measuring unmounted parts are 2.8 x 1.7mm (0612), 0.4 x 1.83mm (0805) 0.4 x 2.8mm (1206), 1.2 x 4.5mm (2010) and 1.5 x 5.8mm (2512). All probe location tolerances ±0.02mm.

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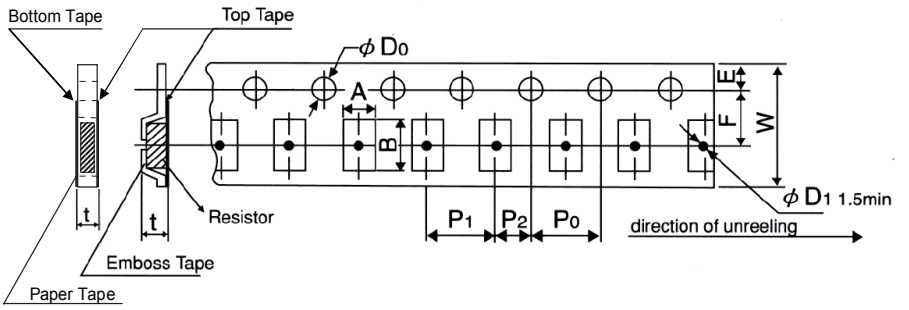
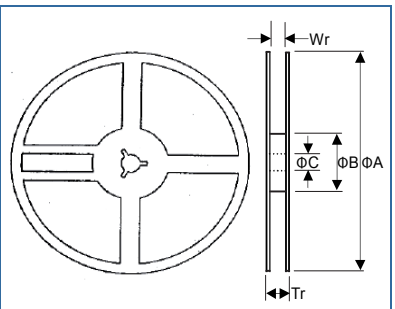
## Packaging




| Size | Tape | A | B | W | F | E | $P_1$ | $P_2$ | $P_0$ | $\Phi D_0$ | t | ΦA | ΦB | ΦC | Wr | Tr |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| **0805** | Paper | 1.6 ±0.15 | 2.4 ±0.2 | 8.0 ±0.2 | 3.5 ±0.05 | 1.75 ±0.1 | 4.0 ±0.1 | 2.0 ±0.1 | 4.0 ±0.1 | 1.5 +0.1/-0 | 0.84 ±0.1 | 178 ± 2 | 60 ±1 | 13 ±1 | 9 ±1 | 11.4 ±1 |
| **0612, 1206** | Paper | 2.0 ±0.15 | 3.6 ±0.2 | 8.0 ±0.2 | 3.5 ±0.05 | 1.75 ±0.1 | 4.0 ±0.1 | 2.0 ±0.05 | 4.0 ±0.1 | 1.5 +0.1/-0 | 0.84 ±0.1 | 178 ± 2 | 60 ±1 | 13 ±1 | 9 ±1 | 11.5 ±1 |
| **0815** | Emboss | 2.6 ±0.2 | 4.5 ±0.2 | 12 ±0.2 | 5.5 ±0.1 | 1.75 ±0.1 | 4.0 +-0.1 | 2.0 ±0.2 | 4.0 ±0.1 | 1.55 ±0.05 | 1.1 ±0.1 | 178 ± 2 | 60 ±1 | 13 ±1 | 13 ±1 | 15.4 ±2 |
| **2010** | Emboss | 2.8 ±0.2 | 5.3 ±0.2 | 12 ±0.05 | 5.5 ±0.05 | 1.75 ±0.1 | 4.0 ±0.1 | 2.0 ±0.05 | 4.0 ±0.05 | 1.5 +0.1/-0 | 0.85 ±0.15 | 178 ± 2 | 60 ±1 | 13 ±1 | 13 ±1 | 15.4 ±2 |
| **2512** | Emboss | 3.6 ±0.2 | 6.9 ±0.2 | 12 ±0.2 | 5.5 ±0.05 | 1.75 ±0.1 | 4.0 ±0.1 | 2.0 ±0.05 | 4.0 ±0.05 | 1.5 +0.1/-0 | 0.85 ±0.15 | 178 ± 2 | 60 ±1 | 13 ±1 | 13 ±1 | 15.4 ±2 |

## Storage

**Conditions:** 5°C to 35°C and 40% to 75%RH
**Shelf life:** 2 years from manufacture

## Processing

LRMA series resistors are suitable for both wave and IR reflow soldering. The recommended reflow profile for Pb-free SAC305 alloy (Sn 96.5%, Ag 3%, Cu 0.5%) soldering is as follows:

**Pre-heat:** 60s to 120s at 150°C to 180°C
**Soldering:** 20s to 40s at ≥230°C
**Peak:** 5s at 250°C to 255°C

# Ordering Procedure

Example: LRMA low thermal EMF version in 2512 size and at 10 milliohms and 1% tolerance packed in tape.

**L R M A M 2 5 1 2 – [1] R 0 1 F T 4**

Type

Version

| T | P | M | N |
|---|---|---|---|

Size

Value (use IEC62 code)

Tolerance (use IEC62 code)

| | |
|---|---|
| F | 1% |
| J | 5% |

Packing

| | | | | |
|---|---|---|---|---|
| T5 | Tape | 0612, 0805, 1206 | 5000/reel | Standard |
| T4 | | 0815, 2010, 2512 | 4000/reel | |

Note 1: For values which require 6 characters, e.g. R00075, the hyphen is omitted.

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